

SMB (DO-214AA)

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Available in unidirectional and bidirectional
- Excellent clamping capability
- Very fast response time
- Low incremental surge resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

PRIMARY CHARACTERISTICS	
V_{BR} (unidirectional)	6.4 V to 49.1 V
V_{BR} (bidirectional)	6.4 V to 49.1 V
V_{WM}	5.0 V to 40 V
P_{PPM} (unidirectional)	1000 W
P_{PPM} (bidirectional)	800 W
I_{FSM} (uni-directional only)	100 A
T_J max.	150 °C
Polarity	Unidirectional, bidirectional
Package	SMB (DO-214AA)

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting on ICs, MOSFET, signal lines of sensor units for consumer, computer, industrial, automotive, and telecommunication.

MECHANICAL DATA

Case: SMB (DO-214AA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B, ...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: for unidirectional types the color band denotes cathode end, no marking on bidirectional types

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power dissipation with a 10/1000 μ s waveform (fig. 1)	P_{PPM} ⁽¹⁾⁽²⁾	1000	W
		800	
Peak pulse current with a 10/1000 μ s waveform	I_{PPM} ⁽¹⁾	See next table	A
Peak forward surge current 8.3 ms single half sine-wave uni-directional only	I_{FSM} ⁽²⁾	100	A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150	°C

Notes

(1) Non-repetitive current pulse, per fig. 3 and derated above $T_A = 25\text{ °C}$ per fig. 2

(2) Mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pads to each terminal

UNIDIRECTIONAL

ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)								
DEVICE TYPE	DEVICE MARKING CODE	BREAKDOWN VOLTAGE V_{BR} AT I_T ⁽¹⁾ (V)		TEST CURRENT I_T (mA)	STAND-OFF VOLTAGE V_{WM} (V)	MAXIMUM REVERSE LEAKAGE AT V_{WM} I_D (μA)	MAXIMUM PEAK PULSE SURGE CURRENT I_{PPM} ⁽²⁾ (A)	MAXIMUM CLAMPING VOLTAGE AT I_{PPM} V_C (V)
		MIN.	MAX.					
SMB10J5.0A	1AE	6.40	7.07	10	5.0	1000	108.7	9.2
SMB10J6.0A	1AG	6.67	7.37	10	6.0	1000	97.1	10.3
SMB10J6.5A	1AK	7.22	7.98	10	6.5	500	89.3	11.2
SMB10J7.0A	1AM	7.78	8.60	10	7.0	200	83.3	12.0
SMB10J7.5A	1AP	8.33	9.21	1.0	7.5	100	77.5	12.9
SMB10J8.0A	1AR	8.89	9.83	1.0	8.0	50	73.5	13.6
SMB10J8.5A	1AT	9.44	10.4	1.0	8.5	20	69.4	14.4
SMB10J9.0A	1AV	10.0	11.1	1.0	9.0	10	64.9	15.4
SMB10J10A	1AX	11.1	12.3	1.0	10	5.0	58.8	17.0
SMB10J11A	1AZ	12.2	13.5	1.0	11	5.0	54.9	18.2
SMB10J12A	1BE	13.3	14.7	1.0	12	5.0	50.3	19.9
SMB10J13A	1BG	14.4	15.9	1.0	13	1.0	46.5	21.5
SMB10J14A	1BK	15.6	17.2	1.0	14	1.0	43.1	23.2
SMB10J15A	1BM	16.7	18.5	1.0	15	1.0	41.0	24.4
SMB10J16A	1BP	17.8	19.7	1.0	16	1.0	38.5	26.0
SMB10J17A	1BR	18.9	20.9	1.0	17	1.0	36.2	27.6
SMB10J18A	1BT	20.0	22.1	1.0	18	1.0	34.2	29.2
SMB10J20A	1BV	22.2	24.5	1.0	20	1.0	30.9	32.4
SMB10J22A	1BX	24.4	26.9	1.0	22	1.0	28.2	35.5
SMB10J24A	1BZ	26.7	29.5	1.0	24	1.0	25.7	38.9
SMB10J26A	1CE	28.9	31.9	1.0	26	1.0	23.8	42.1
SMB10J28A	1CG	31.1	34.4	1.0	28	1.0	22.0	45.4
SMB10J30A	1CK	33.3	36.8	1.0	30	1.0	20.7	48.4
SMB10J33A	1CM	36.7	40.6	1.0	33	1.0	18.8	53.3
SMB10J36A	1CP	40.0	44.2	1.0	36	1.0	17.2	58.1
SMB10J40A	1CR	44.4	49.1	1.0	40	1.0	15.5	64.5

Notes

- (1) Pulse test: $t_p \leq 50\text{ ms}$
- (2) Surge current waveform per fig. 3 and derate per fig. 2
- (3) All terms and symbols are consistent with ANSI/IEEE C62.35
- (4) $V_F = 3.5\text{ V}$ at $I_F = 50\text{ A}$ (uni-directional only)

BIDIRECTIONAL

ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)								
DEVICE TYPE	DEVICE MARKING CODE	BREAKDOWN VOLTAGE V_{BR} AT $I_T^{(1)}$ (V)		TEST CURRENT I_T (mA)	STAND-OFF VOLTAGE V_{WM} (V)	MAXIMUM REVERSE LEAKAGE AT V_{WM} I_D (μA)	MAXIMUM PEAK PULSE SURGE CURRENT $I_{PPM}^{(2)}$ (A)	MAXIMUM CLAMPING VOLTAGE AT I_{PPM} V_C (V)
		MIN.	MAX.					
SMB8J5.0CA	1AE	6.40	7.25	10	5.0	2000	87.0	9.2
SMB8J6.0CA	1AG	6.67	7.37	10	6.0	2000	77.7	10.3
SMB8J6.5CA	1AK	7.22	7.98	10	6.5	1000	71.4	11.2
SMB8J7.0CA	1AM	7.78	8.60	10	7.0	400	66.7	12.0
SMB8J7.5CA	1AP	8.33	9.21	1.0	7.5	200	62.0	12.9
SMB8J8.0CA	1AR	8.89	9.83	1.0	8.0	100	58.8	13.6
SMB8J8.5CA	1AT	9.44	10.4	1.0	8.5	40	55.6	14.4
SMB8J9.0CA	1AV	10.0	11.1	1.0	9.0	20	51.9	15.4
SMB8J10CA	1AX	11.1	12.3	1.0	10	10	47.1	17.0
SMB8J11CA	1AZ	12.2	13.5	1.0	11	5.0	44.0	18.2
SMB8J12CA	1BE	13.3	14.7	1.0	12	5.0	40.2	19.9
SMB8J13CA	1BG	14.4	15.9	1.0	13	1.0	37.2	21.5
SMB8J14CA	1BK	15.6	17.2	1.0	14	1.0	34.5	23.2
SMB8J15CA	1BM	16.7	18.5	1.0	15	1.0	32.8	24.4
SMB8J16CA	1BP	17.8	19.7	1.0	16	1.0	30.8	26.0
SMB8J17CA	1BR	18.9	20.9	1.0	17	1.0	29.0	27.6
SMB8J18CA	1BT	20.0	22.1	1.0	18	1.0	27.4	29.2
SMB8J20CA	1BV	22.2	24.5	1.0	20	1.0	24.7	32.4
SMB8J22CA	1BX	24.4	26.9	1.0	22	1.0	22.5	35.5
SMB8J24CA	1BZ	26.7	29.5	1.0	24	1.0	20.6	38.9
SMB8J26CA	1CE	28.9	31.9	1.0	26	1.0	19.0	42.1
SMB8J28CA	1CG	31.1	34.4	1.0	28	1.0	17.6	45.4
SMB8J30CA	1CK	33.3	36.8	1.0	30	1.0	16.5	48.4
SMB8J33CA	1CM	36.7	40.6	1.0	33	1.0	15.0	53.3
SMB8J36CA	1CP	40.0	44.2	1.0	36	1.0	13.8	58.1
SMB8J40CA	1CR	44.4	49.1	1.0	40	1.0	12.4	64.5

Notes

- (1) Pulse test: $t_p \leq 50\text{ ms}$
(2) Surge current waveform per fig. 3 and derate per fig. 2
(3) All terms and symbols are consistent with ANSI/IEEE C62.35

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VALUE	UNIT
Typical thermal resistance, junction to ambient ⁽¹⁾	$R_{\theta JA}$	72	$^{\circ}\text{C}/\text{W}$
Typical thermal resistance, junction to lead	$R_{\theta JL}$	20	

Note

- (1) Mounted on minimum recommended pad layout

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

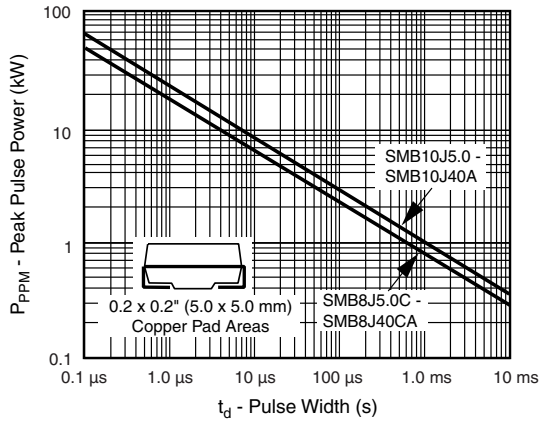


Fig. 1 - Peak Pulse Power Rating Curve

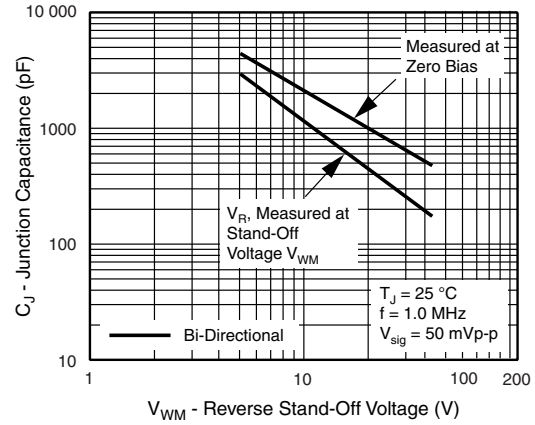


Fig. 4 - Typical Junction Capacitance

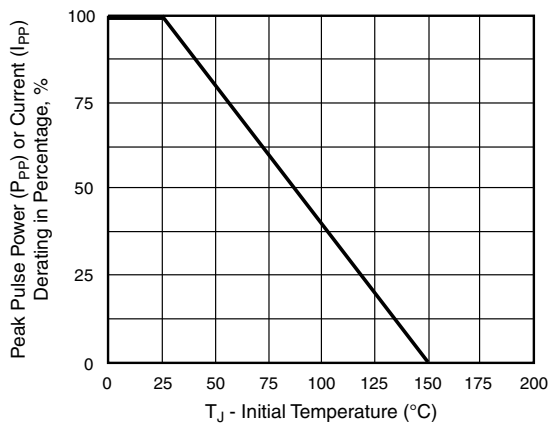


Fig. 2 - Pulse Power or Current vs. Initial Junction Temperature

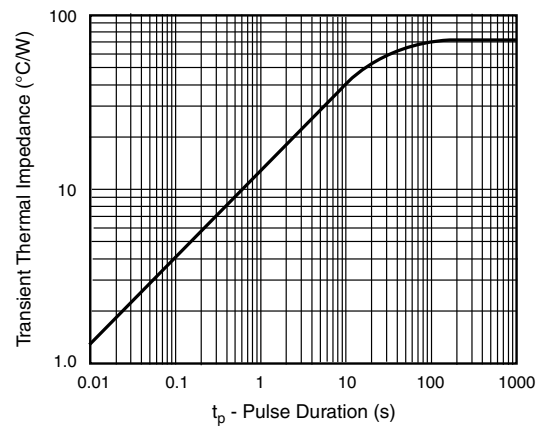


Fig. 5 - Typical Transient Thermal Impedance

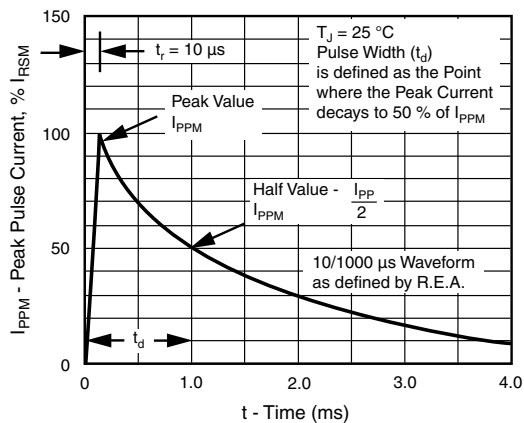


Fig. 3 - Pulse Waveform

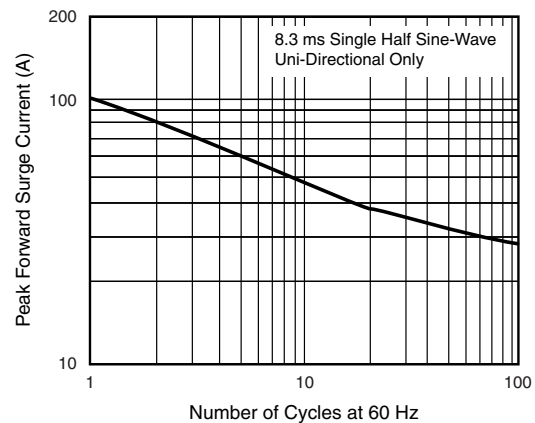
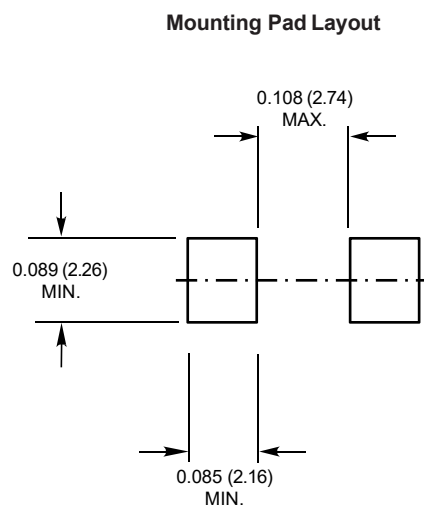
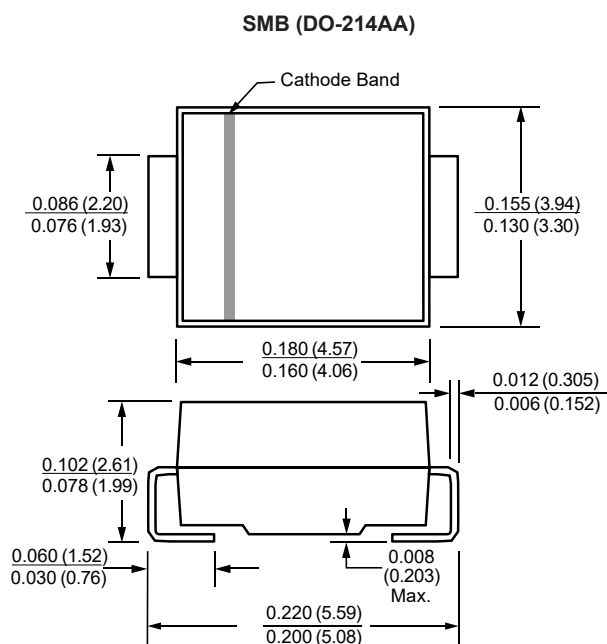


Fig. 6 - Maximum Non-Repetitive Forward Surge Current

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads



Ordering Information (Example)

PREFERED P/N	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SMB10(8)J5.0(C)A thru SMB10(8)J40(C)A	3000	6000	48000	13" reel